HM514400A/AL/ASL Series

T-46-23-18

1,048,576-word × 4-bit Dynamic RAM

HITACHI/ LOGIC/ARRAYS/MEM

The Hitachi HM514400A/AL/ASL is a CMOS dynamic RAM organized 1,048,576-word × 4-bit. HM514400A/AL/ASL has realized higher density, higher performance and various functions by employing 0.8 µm CMOS process technology and some new CMOS circuit design technologies. The HM514400A/AL/ASL offers fast page mode as a high speed access mode.

Multiplexed address input permits the HM514400A/AL/ASL to be packaged in standard 20-pin plastic SOJ, 20-pin plastic ZIP, 20-pin TSOP, and 20-pin ST-ZIP.

Features

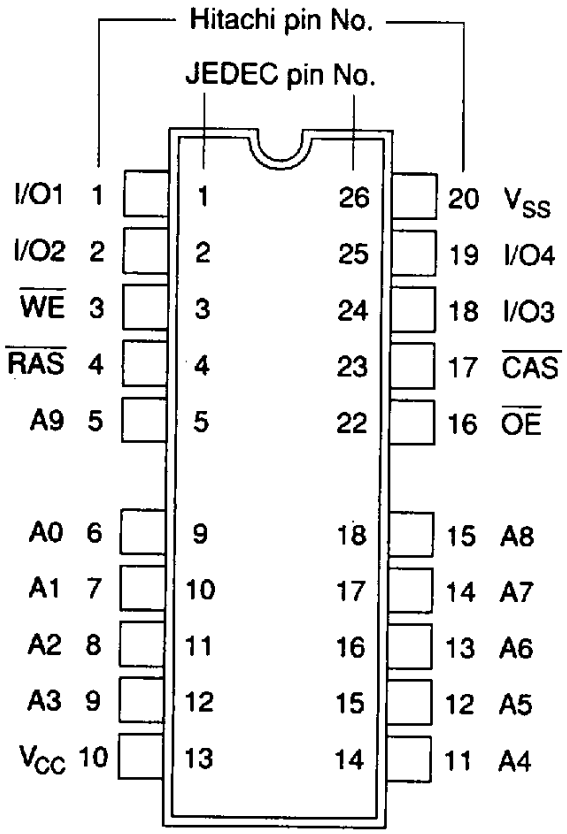
- Single 5 V (±10%)
- High speed
  - Access time
    60 ns/70 ns/80 ns (max)
- Low power dissipation
  - Active mode
    605 mW/550 mW/495 mW (max)
  - Standby mode 11 mW (max)
    0.83 mW (L-version)
    0.55 mW (SL-version)
- Fast page mode capability
- 1,024 refresh cycles: 16 ms
  1,024 refresh cycles: 128 ms (L-version)
- 3 variations of refresh
  - $\overline{\text{RAS}}$-only refresh
  - $\overline{\text{CAS}}$-before-$\overline{\text{RAS}}$ refresh
  - Hidden refresh
- Test function
- Battery back up operation (L-version)
- Data retention operation (SL-version)

Ordering Information

Type No.	Access time	Package
HM514400AJ/ALJ/ASLJ-6 HM514400AJ/ALJ/ASLJ-7 HM514400AJ/ALJ/ASLJ-8	60 ns 70 ns 80 ns	350-mil 20-pin plastic SOJ (CP-20DA)
HM514400AS/ALS/ASLS-6 HM514400AS/ALS/ASLS-7 HM514400AS/ALS/ASLS-8	60 ns 70 ns 80 ns	300-mil 20-pin plastic SOJ (CP-20D)
HM514400AZ/ALZ/ASLZ-6 HM514400AZ/ALZ/ASLZ-7 HM514400AZ/ALZ/ASLZ-8	60 ns 70 ns 80 ns	400-mil 20-pin plastic ZIP (ZP-20)
HM514400AT/ALT/ASLT-6 HM514400AT/ALT/ASLT-7 HM514400AT/ALT/ASLT-8	60 ns 70 ns 80 ns	20-pin plastic TSOP I (TFP-20DA)
HM514400AR/ALR/ASLR-6 HM514400AR/ALR/ASLR-7 HM514400AR/ALR/ASLR-8	60 ns 70 ns 80 ns	20-pin plastic TSOP I reverse type (TFP-20DAR)
HM514400ATT/ALTT/ASLTT-6 HM514400ATT/ALTT/ASLTT-7 HM514400ATT/ALTT/ASLTT-8	60 ns 70 ns 80 ns	20-pin plastic TSOP II (TTP-20D)
HM514400ARR/ALRR/ASLRR-6 HM514400ARR/ALRR/ASLRR-7 HM514400ARR/ALRR/ASLRR-8	60 ns 70 ns 80 ns	20-pin plastic TSOP II reverse type (TTP-20DR)
HM514400ATZ/ALTZ-6 HM514400ATZ/ALTZ-7 HM514400ATZ/ALTZ-8	60 ns 70 ns 80 ns	20-pin plastic ST-ZIP (ZP-20S)

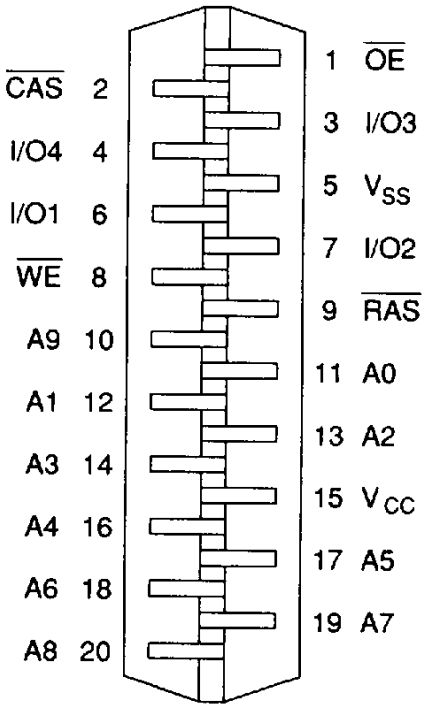
Pin Arrangement

HM514400AJ / ALJ / ASLJ Series
HM514400AS / ALS / ASLS Series



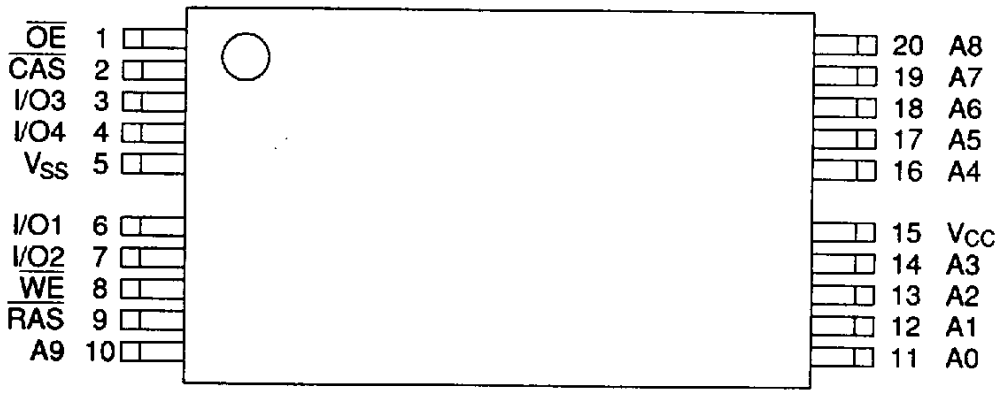
(Top View)

HM514400AZ / ALZ / ASLZ Series
HM514400ATZ/ALTZ Series



(Bottom View)

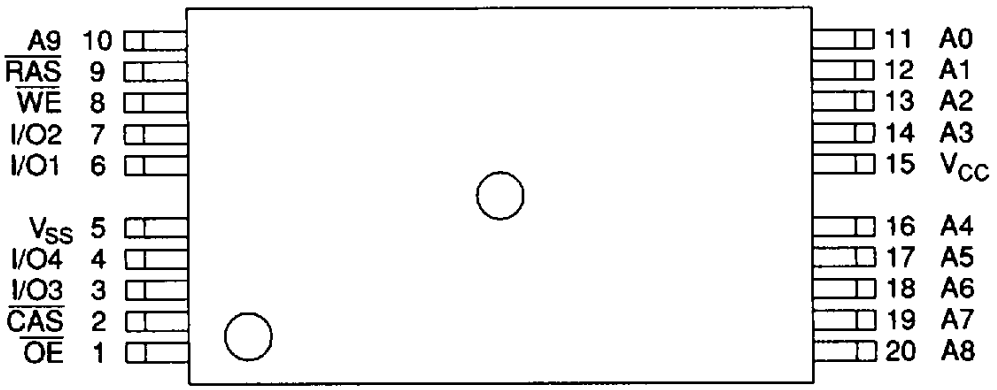
HM514400AT / ALT / ASLT Series



(Top View)

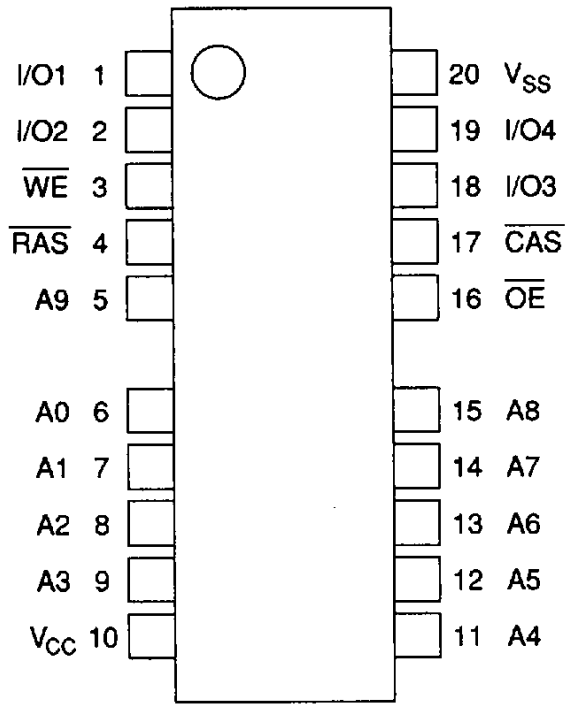
Pin Arrangement (cont)

HM514400AR / ALR / ASLR Series



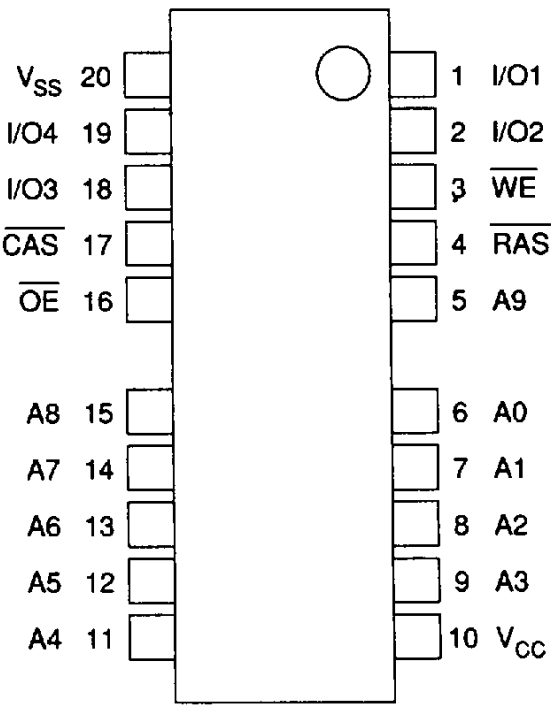
(Top View)

HM514400ATT / ALTT / ASLTT Series



(Top View)

HM514400ARR / ALRR / ASLRR Series

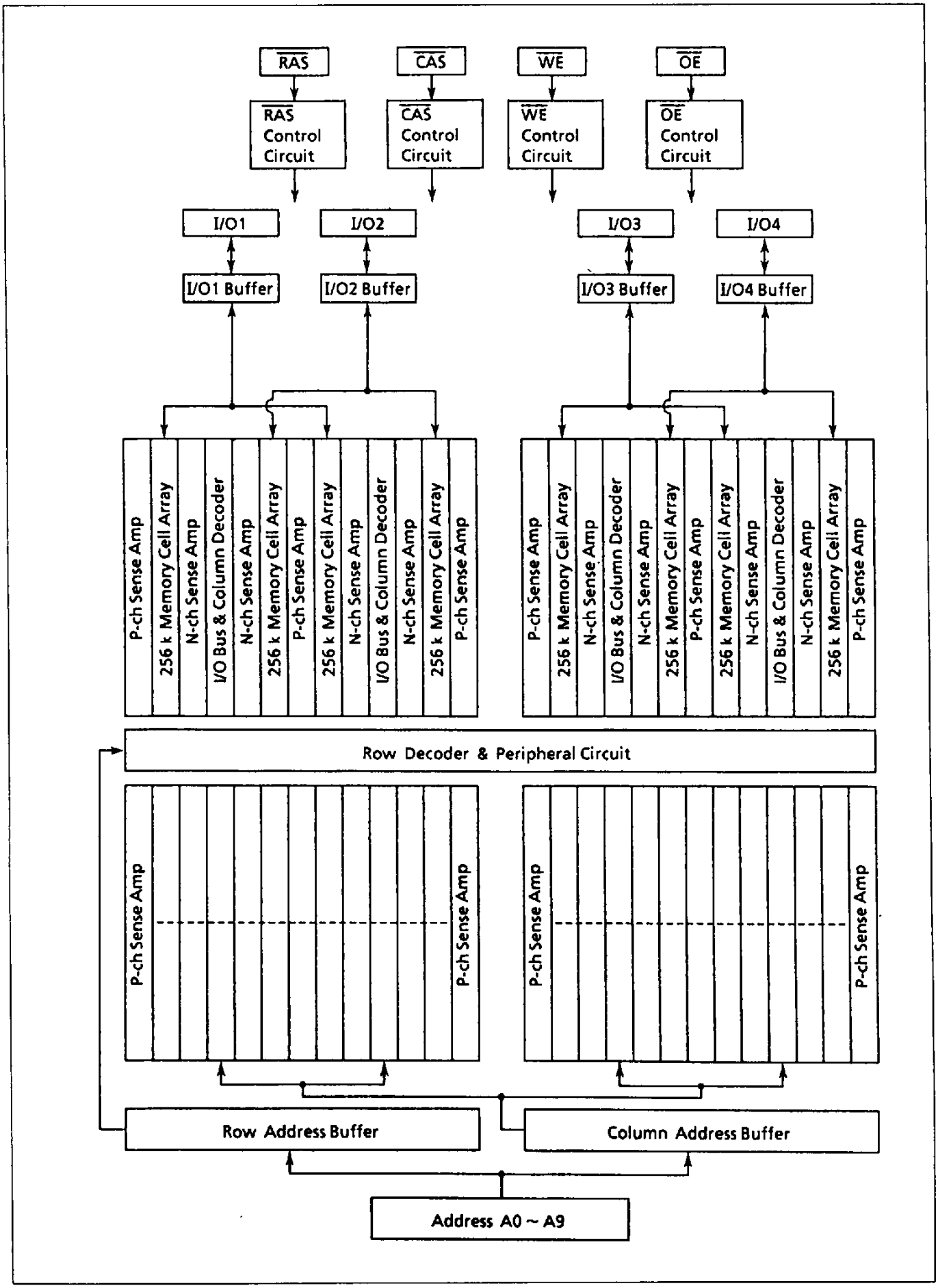


(Top View)

Pin Description

Pin name	Function	Pin name	Function
A0 – A9	Address input	$\overline{WE}$	Read/write enable
A0 – A9	Refresh address input	$\overline{OE}$	Output enable
I/O1 – I/O4	Data-in/data-out	V_{CC}	Power (+5 V)
$\overline{RAS}$	Row address strobe	V_{SS}	Ground
$\overline{CAS}$	Column address strobe		

Block Diagram



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Voltage on any pin relative to V_{SS}	V_T	−1.0 to +7.0	V
Supply voltage relative to V_{SS}	V_{CC}	−1.0 to +7.0	V
Short circuit output current	Iout	50	mA
Power dissipation	P_T	1.0	W
Operating temperature	Topr	0 to +70	°C
Operating temperature (SL-version)	Topr	0 to +60	°C
Storage temperature	Tstg	−55 to +125	°C

Recommended DC Operating Conditions (Ta = 0 to +70°C)
(Ta = 0 to +60°C (SL-version))

Parameter	Symbol	Min	Typ	Max	Unit	Notes
Supply voltage	V_{SS}	0	0	0	V	
	V_{CC}	4.5	5.0	5.5	V	1
		4.0	—	5.5	V	1, 2
Input high voltage	V_{IH}	2.4	—	6.5	V	1
Input low voltage	V_{IL}	−1.0	—	0.8	V	1

Notes: 1. All voltage referenced to V_{SS}
2. Only for data retention operation (SL-version)

DC Characteristics

(Ta = 0 to +70°C, V_{CC} = 5 V ± 10%, V_{SS} = 0 V)
(Ta = 0 to +60°C, V_{CC} = 5 V ± 10%, V_{SS} = 0 V (SL-version))

		HM514400A -6		HM514400A -7		HM514400A -8				
Parameter	**Symbol**	**Min**	**Max**	**Min**	**Max**	**Min**	**Max**	**Unit**	**Test conditions**	**Notes**
Operating current	I_{CC1}	—	110	—	100	—	90	mA	$\overline{RAS}$, $\overline{CAS}$ cycling t_{RC} = min	1, 2
Standby current	I_{CC2}	—	2	—	2	—	2	mA	TTL interface $\overline{RAS}$, $\overline{CAS}$ = V_{IH} Dout = High-Z	
		—	1	—	1	—	1	mA	CMOS interface $\overline{RAS}$, $\overline{CAS}$ ≥ V_{CC} – 0.2 V Dout = High-Z	
Standby current (L-version)		—	150	—	150	—	150	µA	CMOS interface $\overline{RAS}$, $\overline{CAS}$ = V_{IH} $\overline{WE}$, $\overline{OE}$, address, Din = V_{IH} or V_{IL} Dout = High-Z	4
Standby current (SL-version)		—	100	—	100	—	100	µA		
$\overline{RAS}$-only refresh current	I_{CC3}	—	110	—	100	—	90	mA	t_{RC} = min	2
Standby current	I_{CC5}	—	5	—	5	—	5	mA	$\overline{RAS}$ = V_{IH} $\overline{CAS}$ = V_{IL} Dout = enable	1
$\overline{CAS}$-before-$\overline{RAS}$ refresh current	I_{CC6}	—	110	—	100	—	90	mA	t_{RC} = min	
Fast page mode current	I_{CC7}	—	110	—	100	—	90	mA	t_{PC} = min	1, 3
Battery back up operation current (CBR refresh) (L-version)	I_{CC10}	—	200	—	200	—	200	µA	t_{RC} = 125 µs t_{RAS} ≤ 1 µs $\overline{WE}$ = V_{IH}, $\overline{CAS}$ = V_{IL} OE, address, Din = V_{IH} or V_{IL} Dout = High-Z	4
Data retention current (CBR refresh) (SL-version)		—	150	—	150	—	150	µA	t_{RC} = 250 µs t_{RAS} ≤ 200 ns $\overline{WE}$ = V_{IH}, $\overline{CAS}$ = V_{IL} $\overline{OE}$, address, Din = V_{IH} or V_{IL} Dout = High-Z 4.0 V ≤ V_{CC} ≤ 5.5 V	4

DC Characteristics (Ta = 0 to +70°C, V_{CC} = 5 V ± 10%, V_{SS} = 0 V) (Ta = 0 to +60°C, V_{CC} = 5 V ± 10%, V_{SS} = 0 V (SL-version)) (cont)

		HM514400A -6		HM514400A -7		HM514400A -8				
Parameter	**Symbol**	**Min**	**Max**	**Min**	**Max**	**Min**	**Max**	**Unit**	**Test conditions**	**Notes**
Input leakage current	I_{LI}	–10	10	–10	10	–10	10	µA	0 V ≤ Vin ≤ 7 V	
Output leakage current	I_{LO}	–10	10	–10	10	–10	10	µA	0 V ≤ Vout ≤ 7 V Dout = disable	
Output high voltage	V_{OH}	2.4	V_{CC}	2.4	V_{CC}	2.4	V_{CC}	V	High Iout = –5 mA	
Output low voltage	V_{OL}	0	0.4	0	0.4	0	0.4	V	Low Iout = 4.2 mA	

Notes: 1. I_{CC} depends on output load condition when the device is selected. I_{CC} max is specified at the output open condition.
2. Address can be changed twice or less while $\overline{RAS}$ = V_{IL}.
3. Address can be changed once or less while $\overline{CAS}$ = V_{IH}.
4. V_{CC} – 0.2 V ≤ V_{IH} ≤ 6.5 V, 0 V ≤ V_{IL} ≤ 0.2 V.

Capacitance (Ta = 25°C, V_{CC} = 5 V ± 10%)

Parameter	**Symbol**	**Typ**	**Max**	**Unit**	**Notes**
Input capacitance (Address)	C_{I1}	—	5	pF	1, 3
Input capacitance (Clocks)	C_{I2}	—	7	pF	1
Output capacitance (Data-in, data-out)	$C_{I/O}$	—	10	pF	1, 2

Notes: 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.
2. $\overline{CAS}$ = V_{IH} to disable Dout
3. C_{I1} (max) = 7 pF for HM514100ATZ/ALTZ Series.

AC Characteristics (Ta = 0°C to +70°C, V_{CC} = 5 V ± 10%, V_{SS} = 0 V)*1, *14, *15, *16

(Ta = 0°C to +60°C, V_{CC} = 5 V ± 10%, V_{SS} = 0 V (SL-version))

Test Conditions

Input rise and fall times: 5 ns
Input timing reference levels: 0.8 V, 2.4 V
Output load: 2 TTL gate + C_L (100 pF)
(Including scope and jig)

Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters)

		HM514400A -6		HM514400A -7		HM514400A -8			
Parameter	**Symbol**	**Min**	**Max**	**Min**	**Max**	**Min**	**Max**	**Unit**	**Notes**
Random read or write cycle time	t_{RC}	110	—	130	—	150	—	ns	
$\overline{RAS}$ precharge time	t_{RP}	40	—	50	—	60	—	ns	
$\overline{RAS}$ pulse width	t_{RAS}	60	10000	70	10000	80	10000	ns	19
$\overline{CAS}$ pulse width	t_{CAS}	15	10000	20	10000	20	10000	ns	20
Row address setup time	t_{ASR}	0	—	0	—	0	—	ns	
Row address hold time	t_{RAH}	10	—	10	—	10	—	ns	
Column address setup time	t_{ASC}	0	—	0	—	0	—	ns	
Column address hold time	t_{CAH}	15	—	15	—	15	—	ns	
$\overline{RAS}$ to $\overline{CAS}$ delay time	t_{RCD}	20	45	20	50	20	60	ns	8
$\overline{RAS}$ to column address delay time	t_{RAD}	15	30	15	35	15	40	ns	9
$\overline{RAS}$ hold time	t_{RSH}	15	—	20	—	20	—	ns	
$\overline{CAS}$ hold time	t_{CSH}	60	—	70	—	80	—	ns	
$\overline{CAS}$ to $\overline{RAS}$ precharge time	t_{CRP}	10	—	10	—	10	—	ns	
$\overline{OE}$ to Din delay time	t_{ODD}	15	—	20	—	20	—	ns	
$\overline{OE}$ delay time from Din	t_{DZO}	0	—	0	—	0	—	ns	
$\overline{CAS}$ setup time from Din	t_{DZC}	0	—	0	—	0	—	ns	
Transition time (rise and fall)	t_T	3	50	3	50	3	50	ns	7

Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters) (cont)

Parameter	Symbol	HM514400A -6 Min	HM514400A -6 Max	HM514400A -7 Min	HM514400A -7 Max	HM514400A -8 Min	HM514400A -8 Max	Unit	Notes
Refresh period	t_{REF}	—	16	—	16	—	16	ms	
Refresh period (L-version)	t_{REF}	—	128	—	128	—	128	ms	
Refresh period (SL-version)	t_{REF}	—	256	—	256	—	256	ms	21

Read Cycle

Parameter	Symbol	HM514400A -6 Min	HM514400A -6 Max	HM514400A -7 Min	HM514400A -7 Max	HM514400A -8 Min	HM514400A -8 Max	Unit	Notes
Access time from $\overline{RAS}$	t_{RAC}	—	60	—	70	—	80	ns	2, 3, 17
Access time from $\overline{CAS}$	t_{CAC}	—	15	—	20	—	20	ns	3, 4, 13, 17
Access time from address	t_{AA}	—	30	—	35	—	40	ns	3, 5, 13, 17
Access time from $\overline{OE}$	t_{OAC}	—	15	—	20	—	20	ns	3, 17
Read command setup time	t_{RCS}	0	—	0	—	0	—	ns	
Read command hold time to $\overline{CAS}$	t_{RCH}	0	—	0	—	0	—	ns	18
Read command hold time to $\overline{RAS}$	t_{RRH}	0	—	0	—	0	—	ns	18
Column address to $\overline{RAS}$ lead time	t_{RAL}	30	—	35	—	40	—	ns	
Output buffer turn-off time	t_{OFF1}	0	15	0	20	0	20	ns	6
Output buffer turn-off to $\overline{OE}$	t_{OFF2}	0	15	0	20	0	20	ns	6
$\overline{CAS}$ to Din delay time	t_{CDD}	15	—	20	—	20	—	ns	
$\overline{OE}$ pulse width	t_{OEP}	15	—	20	—	20	—	ns	

Write Cycle

Parameter	Symbol	HM514400A-6 Min	HM514400A-6 Max	HM514400A-7 Min	HM514400A-7 Max	HM514400A-8 Min	HM514400A-8 Max	Unit	Notes
Write command setup time	t_{WCS}	0	—	0	—	0	—	ns	10
Write command hold time	t_{WCH}	15	—	15	—	15	—	ns	
Write command pulse width	t_{WP}	10	—	10	—	10	—	ns	
Write command to $\overline{RAS}$ lead time	t_{RWL}	15	—	20	—	20	—	ns	
Write command to $\overline{CAS}$ lead time	t_{CWL}	15	—	20	—	20	—	ns	
Data-in setup time	t_{DS}	0	—	0	—	0	—	ns	11
Data-in hold time	t_{DH}	15	—	15	—	15	—	ns	11

Read-Modify-Write Cycle

Parameter	Symbol	HM514400A-6 Min	HM514400A-6 Max	HM514400A-7 Min	HM514400A-7 Max	HM514400A-8 Min	HM514400A-8 Max	Unit	Notes
Read-modify-write cycle time	t_{RWC}	150	—	180	—	200	—	ns	
$\overline{RAS}$ to $\overline{WE}$ delay time	t_{RWD}	80	—	95	—	105	—	ns	10
$\overline{CAS}$ to $\overline{WE}$ delay time	t_{CWD}	35	—	45	—	45	—	ns	10
Column address to $\overline{WE}$ delay time	t_{AWD}	50	—	60	—	65	—	ns	10
$\overline{OE}$ hold time from $\overline{WE}$	t_{OEH}	15	—	20	—	20	—	ns	

Refresh Cycle

Parameter	Symbol	HM514400A -6 Min	HM514400A -6 Max	HM514400A -7 Min	HM514400A -7 Max	HM514400A -8 Min	HM514400A -8 Max	Unit	Notes
$\overline{CAS}$ setup time ($\overline{CAS}$-before-$\overline{RAS}$ refresh cycle)	t_{CSR}	10	—	10	—	10	—	ns	
$\overline{CAS}$ hold time ($\overline{CAS}$-before-$\overline{RAS}$ refresh cycle)	t_{CHR}	10	—	10	—	10	—	ns	
$\overline{RAS}$ precharge to $\overline{CAS}$ hold time	t_{RPC}	10	—	10	—	10	—	ns	
$\overline{CAS}$ precharge time in normal mode	t_{CPN}	10	—	10	—	10	—	ns	

Fast Page Mode Cycle

Parameter	Symbol	HM514400A -6 Min	HM514400A -6 Max	HM514400A -7 Min	HM514400A -7 Max	HM514400A -8 Min	HM514400A -8 Max	Unit	Notes
Fast page mode cycle time	t_{PC}	40	—	45	—	50	—	ns	
Fast page mode $\overline{CAS}$ precharge time	t_{CP}	10	—	10	—	10	—	ns	
Fast page mode $\overline{RAS}$ pulse width	t_{RASC}	—	100000	—	100000	—	100000	ns	12
Access time from $\overline{CAS}$ precharge	t_{ACP}	—	35	—	40	—	45	ns	3, 13, 17
$\overline{RAS}$ hold time from $\overline{CAS}$ precharge	t_{RHCP}	35	—	40	—	45	—	ns	

Fast Page Mode Read-Modify-Write Cycle

Parameter	Symbol	HM514400A -6 Min	HM514400A -6 Max	HM514400A -7 Min	HM514400A -7 Max	HM514400A -8 Min	HM514400A -8 Max	Unit	Notes
Fast page mode read-modify-write cycle time	t_{PCM}	80	—	95	—	100	—	ns	
$\overline{CAS}$ precharge to $\overline{WE}$ delay time	t_{CPW}	55	—	65	—	70	—	ns	10

Test Mode Cycle

Parameter	Symbol	HM514400A -6 Min	HM514400A -6 Max	HM514400A -7 Min	HM514400A -7 Max	HM514400A -8 Min	HM514400A -8 Max	Unit	Notes
Test mode $\overline{WE}$ setup time	t_{WS}	0	—	0	—	0	—	ns	
Test mode $\overline{WE}$ hold time	t_{WH}	10	—	10	—	10	—	ns	

Counter Test Cycle

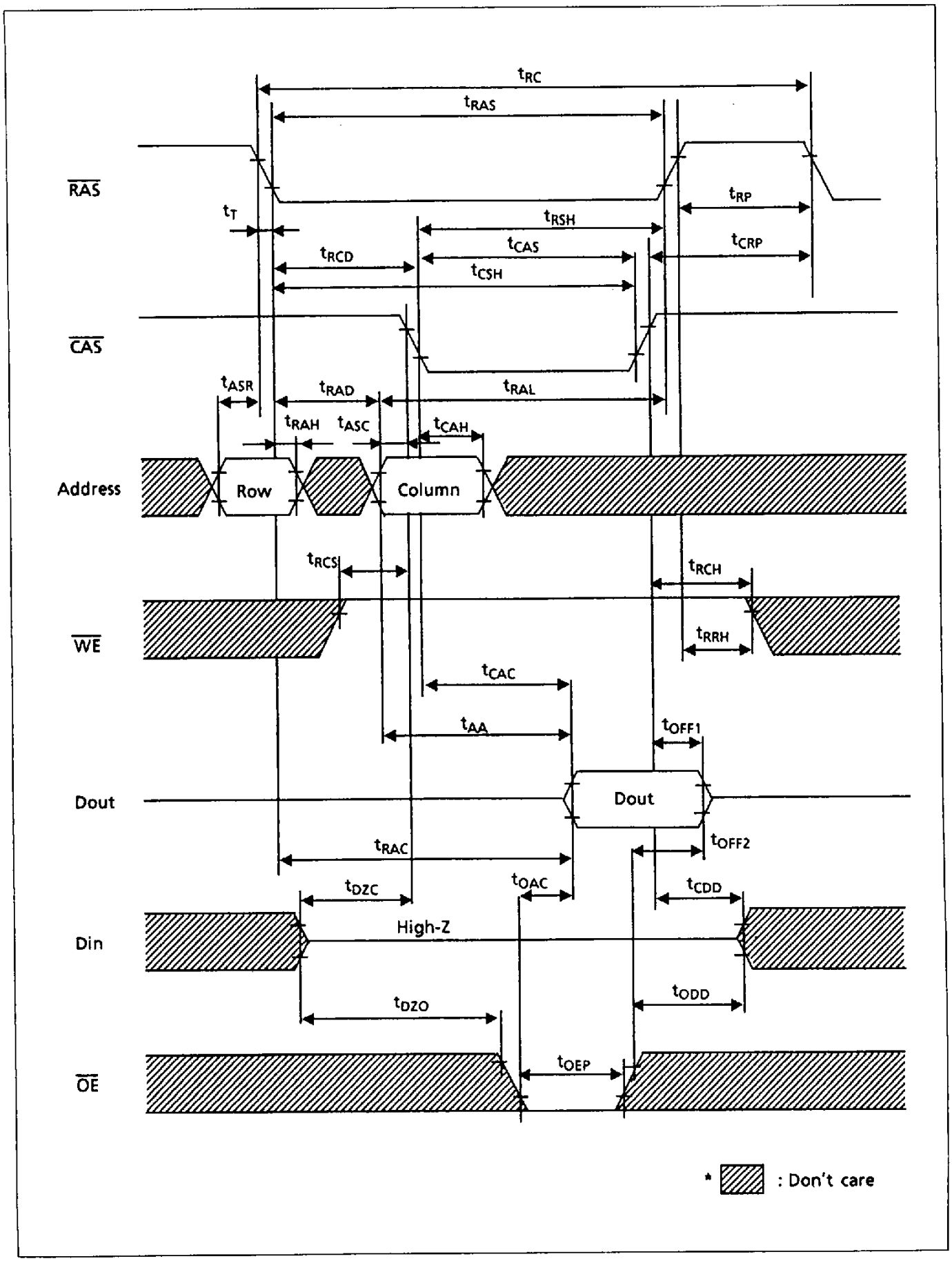
Parameter	Symbol	HM514400A -6 Min	HM514400A -6 Max	HM514400A -7 Min	HM514400A -7 Max	HM514400A -8 Min	HM514400A -8 Max	Unit	Notes
$\overline{CAS}$ precharge time in counter test cycle	t_{CPT}	40	—	40	—	40	—	ns	

Notes:
1. AC measurements assume t_T = 5 ns.
2. Assumes that $t_{RCD} \leq t_{RCD}$ (max) and $t_{RAD} \leq t_{RAD}$ (max). If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} exceeds the value shown.
3. Measured with a load circuit equivalent to 2 TTL loads and 100 pF.
4. Assumes that $t_{RCD} \geq t_{RCD}$ (max) and $t_{RAD} \leq t_{RAD}$ (max).
5. Assumes that $t_{RCD} \leq t_{RCD}$ (max) and $t_{RAD} \geq t_{RAD}$ (max).
6. t_{OFF} (max) defines the time at which the output achieves the open circuit condition and is not referenced to output voltage levels.
7. V_{IH} (min) and V_{IL} (max) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} and V_{IL}.
8. Operation with the t_{RCD} (max) limit insures that t_{RAC} (max) can be met, t_{RCD} (max) is specified as a reference point only, if t_{RCD} is greater than the specified t_{RCD} (max) limit, then access time is controlled exclusively by t_{CAC}.
9. Operation with the t_{RAD} (max) limit insures that t_{RAC} (max) can be met, t_{RAD} (max) is specified as a reference point only, if t_{RAD} is greater than the specified t_{RAD} (max) limit, then access time is controlled exclusively by t_{AA}.
10. t_{WCS}, t_{RWD}, t_{CWD}, t_{AWD} and t_{CPW} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only: if $t_{WCS} \geq t_{WCS}$ (min), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if $t_{RWD} \geq t_{RWD}$ (min), $t_{CWD} \geq t_{CWD}$ (min), $t_{AWD} \geq t_{AWD}$ (min) and $t_{CPW} \geq t_{CPW}$ (min) the cycle is a read-modify-write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
11. These parameters are referenced to $\overline{CAS}$ leading edge in an early write cycle and to $\overline{WE}$ leading edge in a delayed write or a read-modify-write cycle.
12. t_{RASC} defines $\overline{RAS}$ pulse width in fast page mode cycles.
13. Access time is determined by the longest of t_{AA} or t_{CAC} or t_{ACP}.
14. An initial pause of 100 µs is required after power up followed by a minimum of eight initialization cycles ($\overline{RAS}$-only refresh cycle or $\overline{CAS}$-before-$\overline{RAS}$ refresh cycle). If the internal refresh counter is used, a minimum of eight $\overline{CAS}$-before-$\overline{RAS}$ refresh cycles is required.
15. In delayed write or read-modify-write cycles, $\overline{OE}$ must disable output buffers prior to applying data to the device.

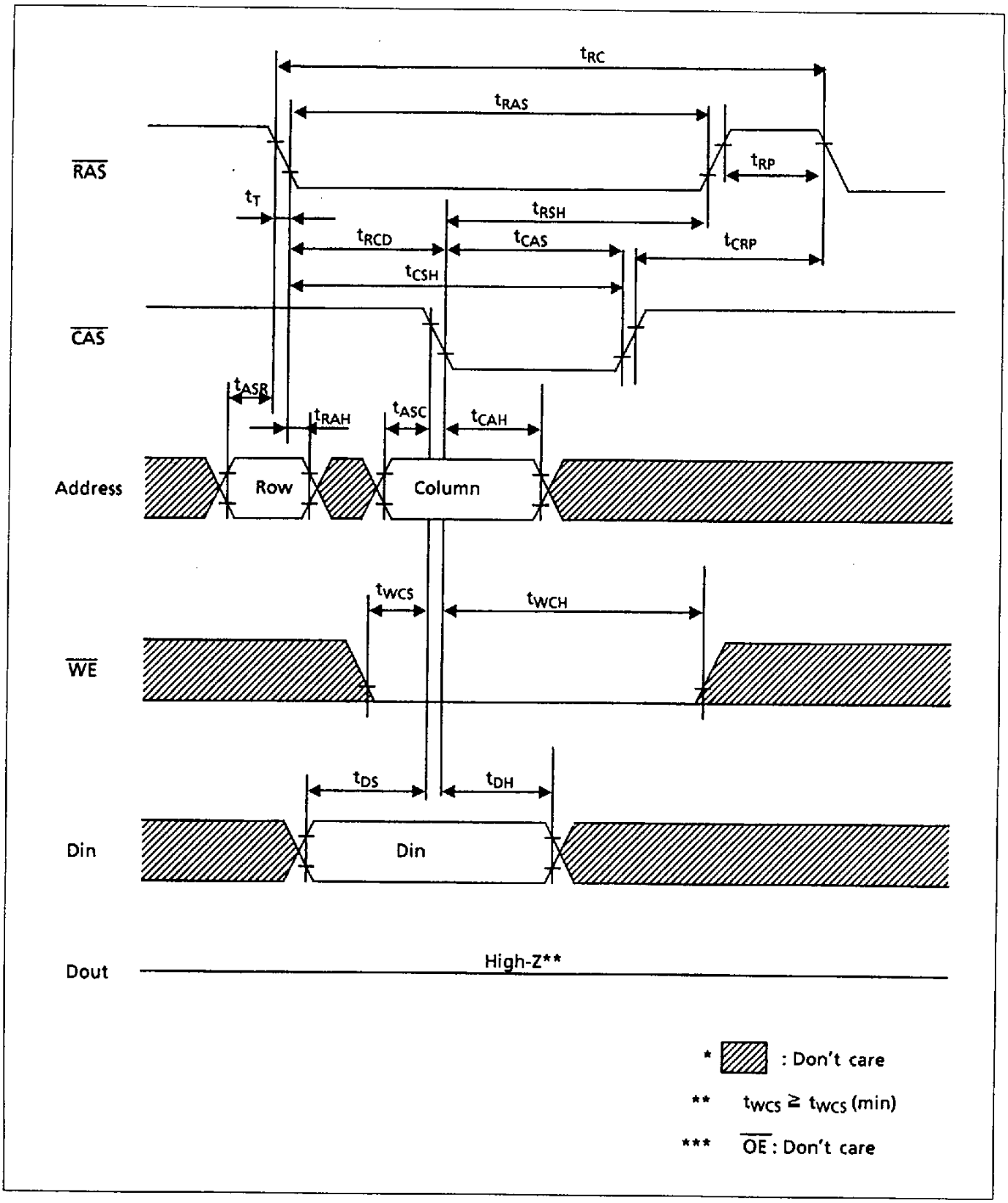
16. Test mode operation specified in this data sheet is 2-bit test function controlled by control address bits – CA0. This test mode operation can be performed by $\overline{WE}$-and-$\overline{CAS}$-before-$\overline{RAS}$ (WCBR) refresh cycle. Refresh during test mode operation will be performed by normal read cycles or by WCBR refresh cycles. When the state of two test bits accord each other, the condition of the output data is high level. When the state of test bits do not accord, the condition of the output data is low level. In order to end this test mode operation, perform a $\overline{RAS}$-only refresh cycle or a $\overline{CAS}$-before-$\overline{RAS}$ refresh cycle.
17. In a test mode read cycle, the value of t_{RAC}, t_{CAC}, t_{AA}, t_{OAC} and t_{ACP} is delayed for 2 ns to 5 ns for the specified value. These parameters should be specified in test mode cycles by adding the above value to the specified value in this data sheet.
18. Either t_{RCH} or t_{RRH} must be satisfied.
19. t_{RAS} (min) = t_{RWD} (min) + t_{RWL} (min) + t_T in read-modify-write cycle.
20. t_{CAS} (min) = t_{CWD} (min) + t_{CWL} (min) + t_T in read-modify-write cycle.
21. t_{REF} is 16 ms without data retention.

Timing Waveforms

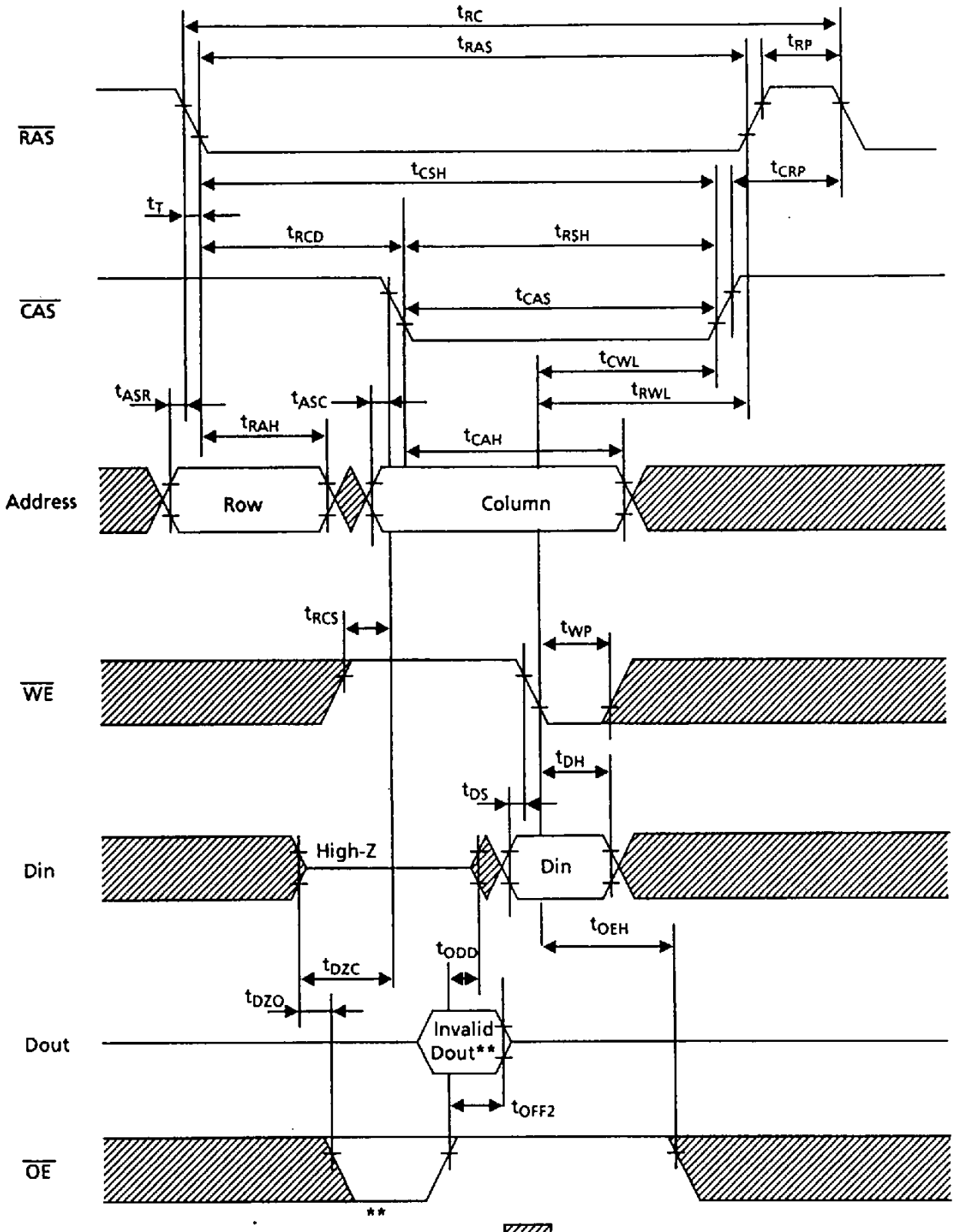
Read Cycle



Early Write Cycle



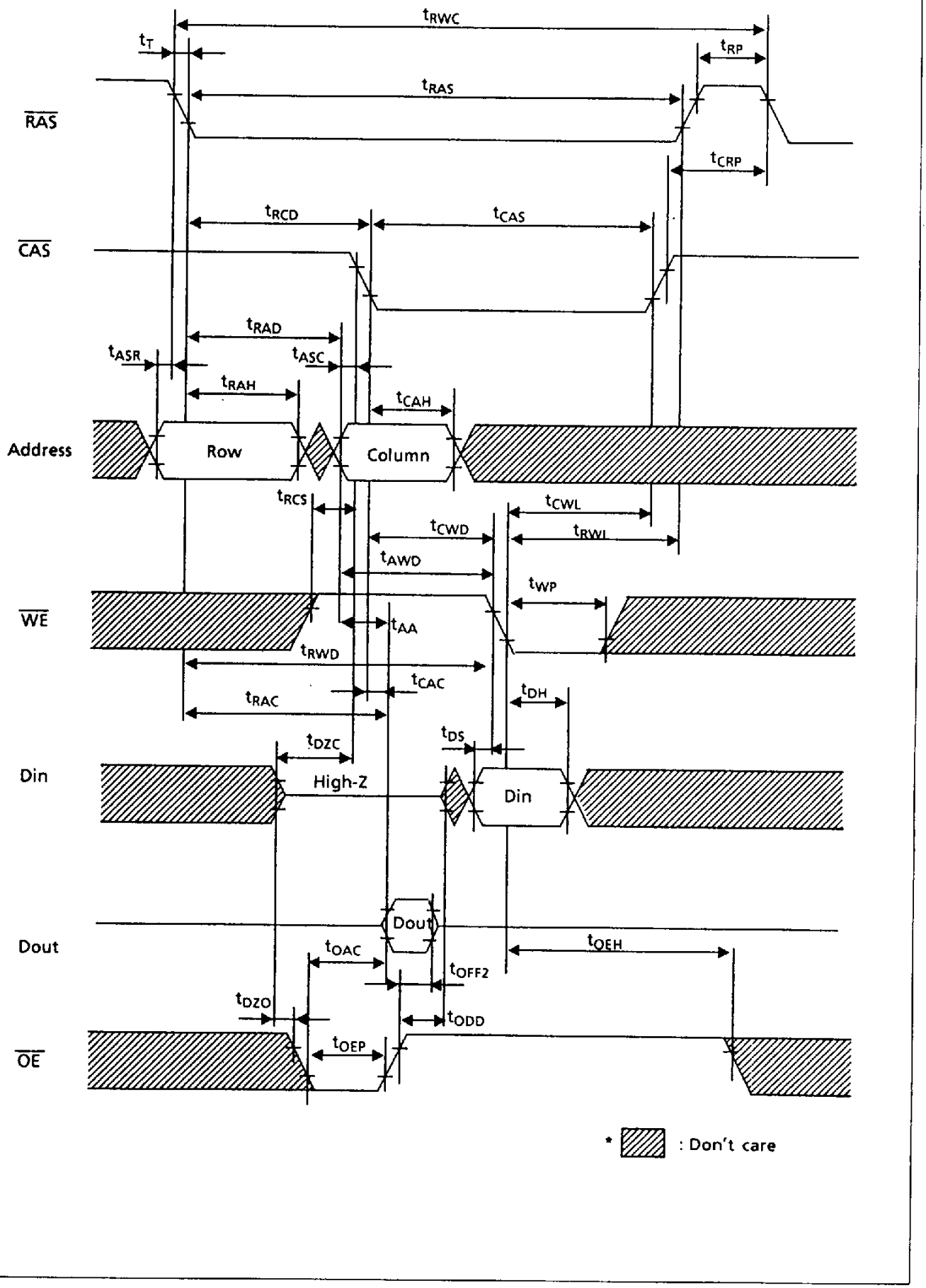
Delayed Write Cycle



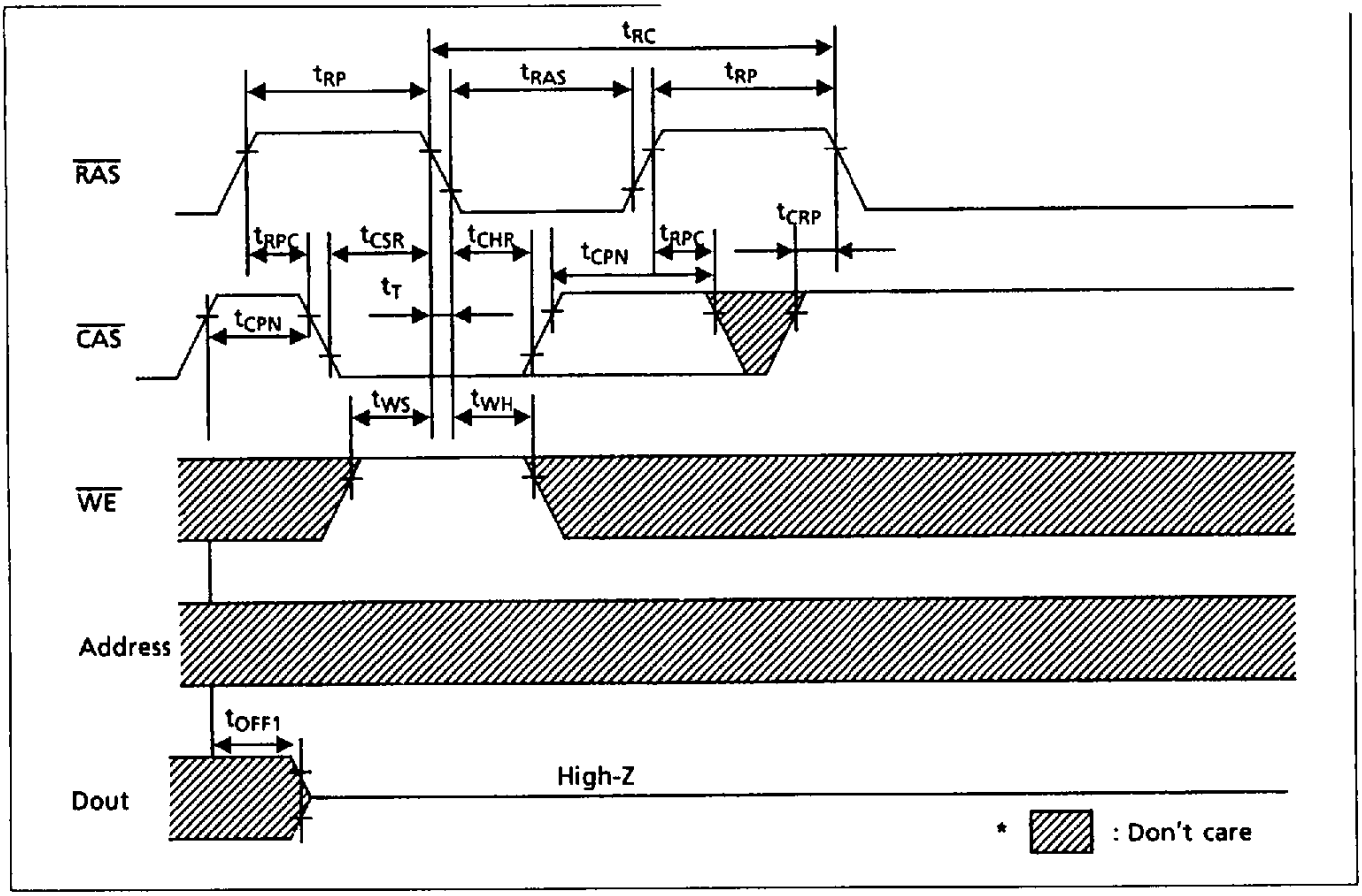
* ▨ : Don't care

** Invalid Dout comes out, when $\overline{OE}$ is low level.

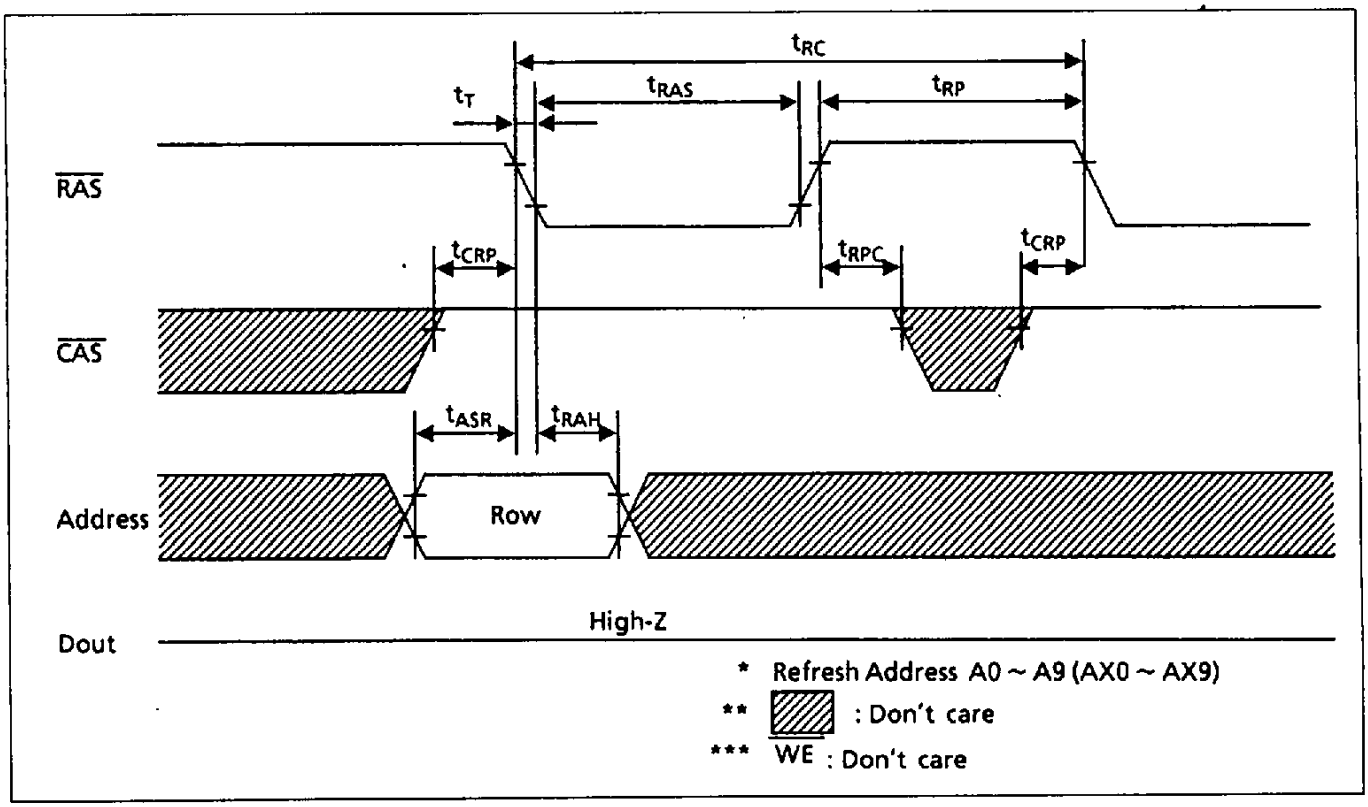
Read-Modify-Write Cycle



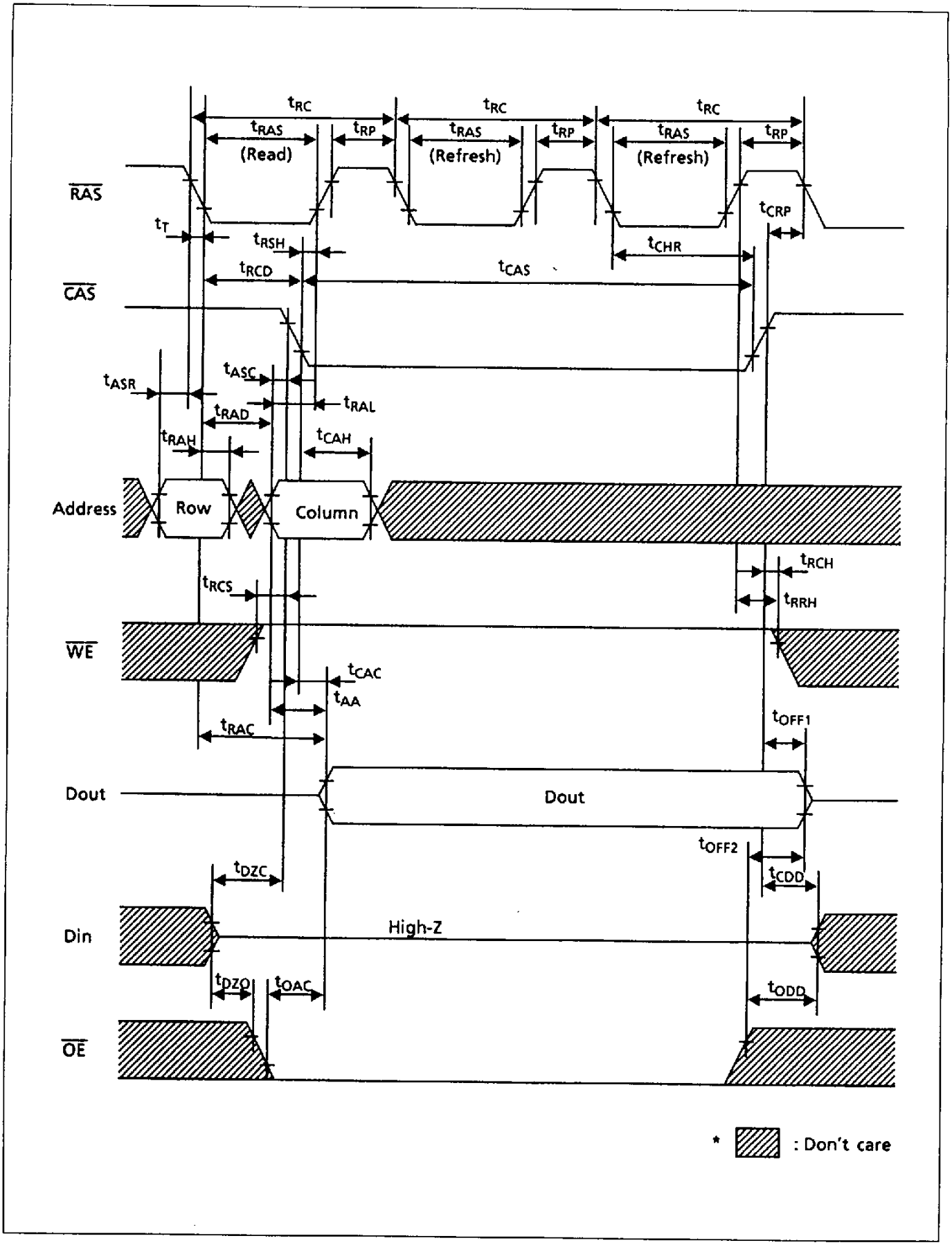
CAS-Before-RAS Refresh Cycle



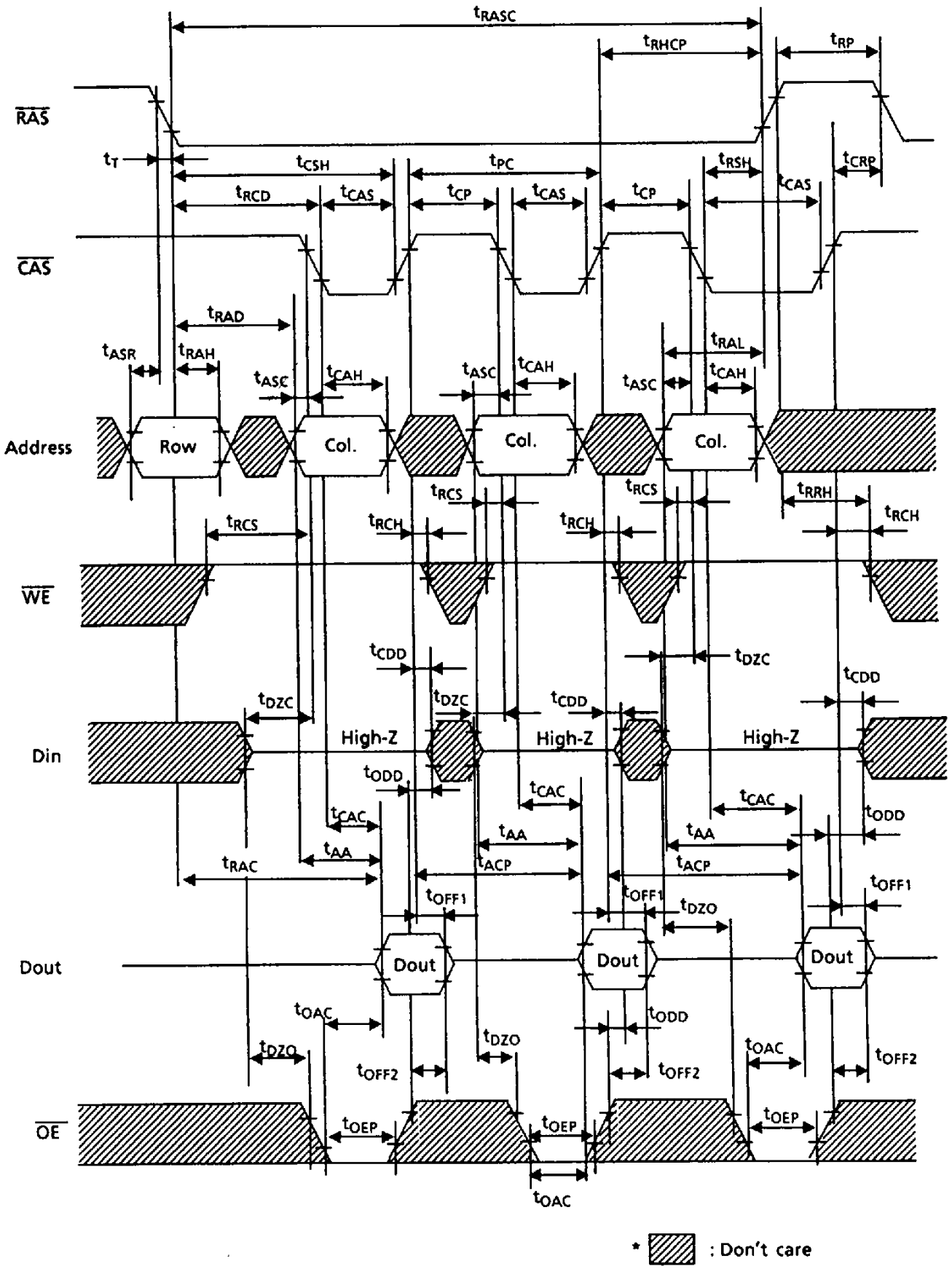
RAS-Only Refresh Cycle



Hidden Refresh Cycle

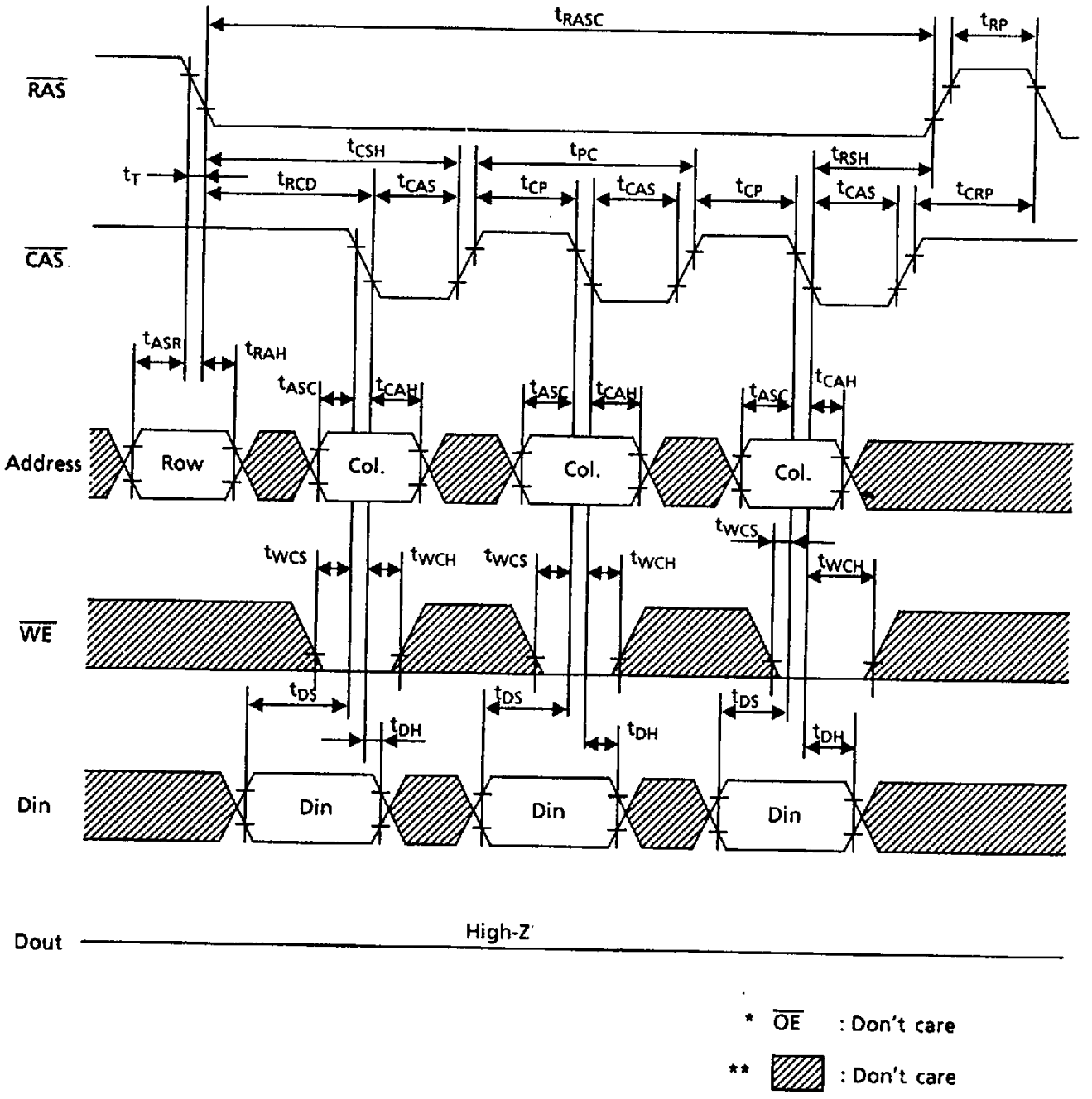


Fast Page Mode Read Cycle

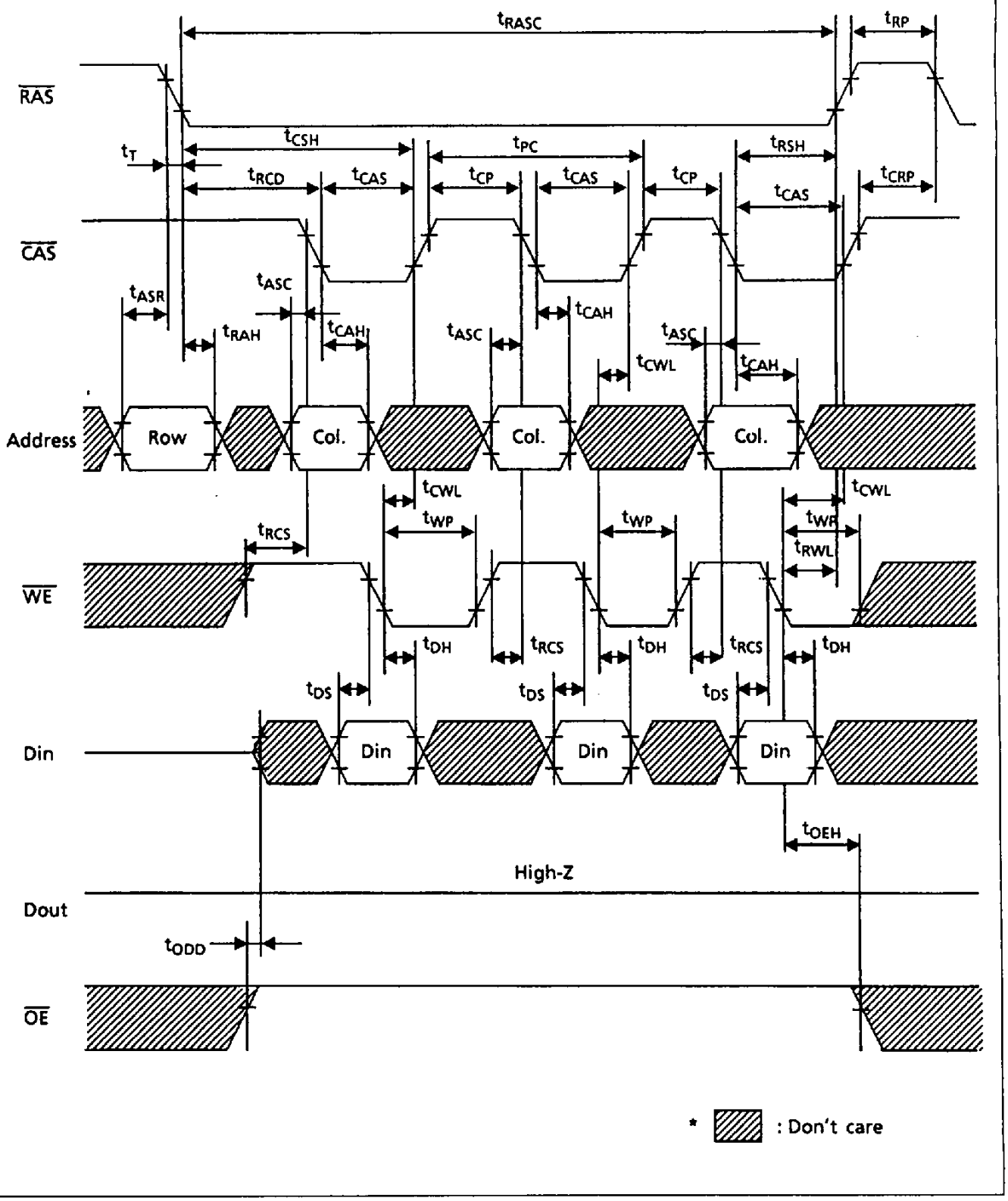


HM514400A/AL/ASL Series

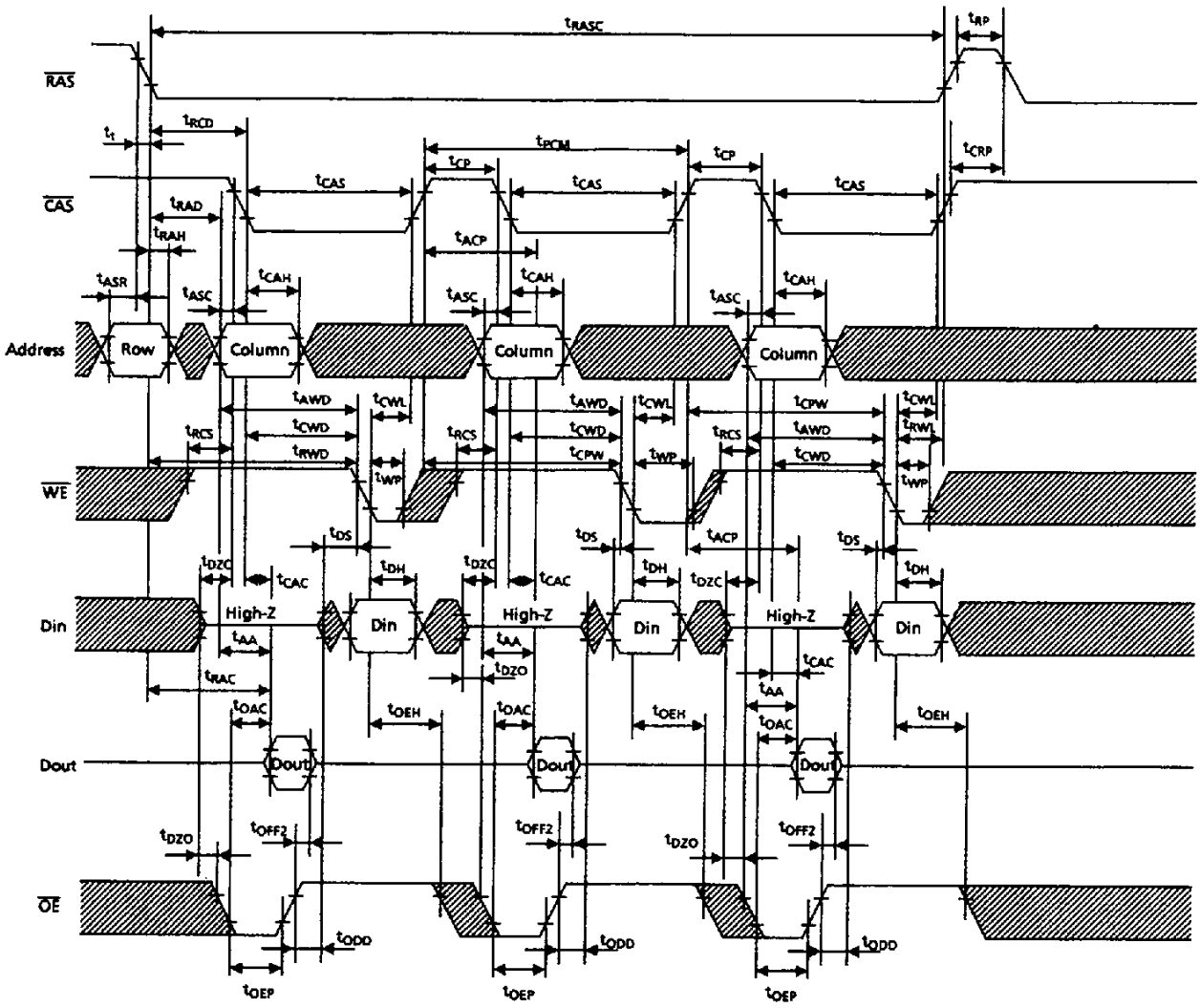
Fast Page Mode Early Write Cycle



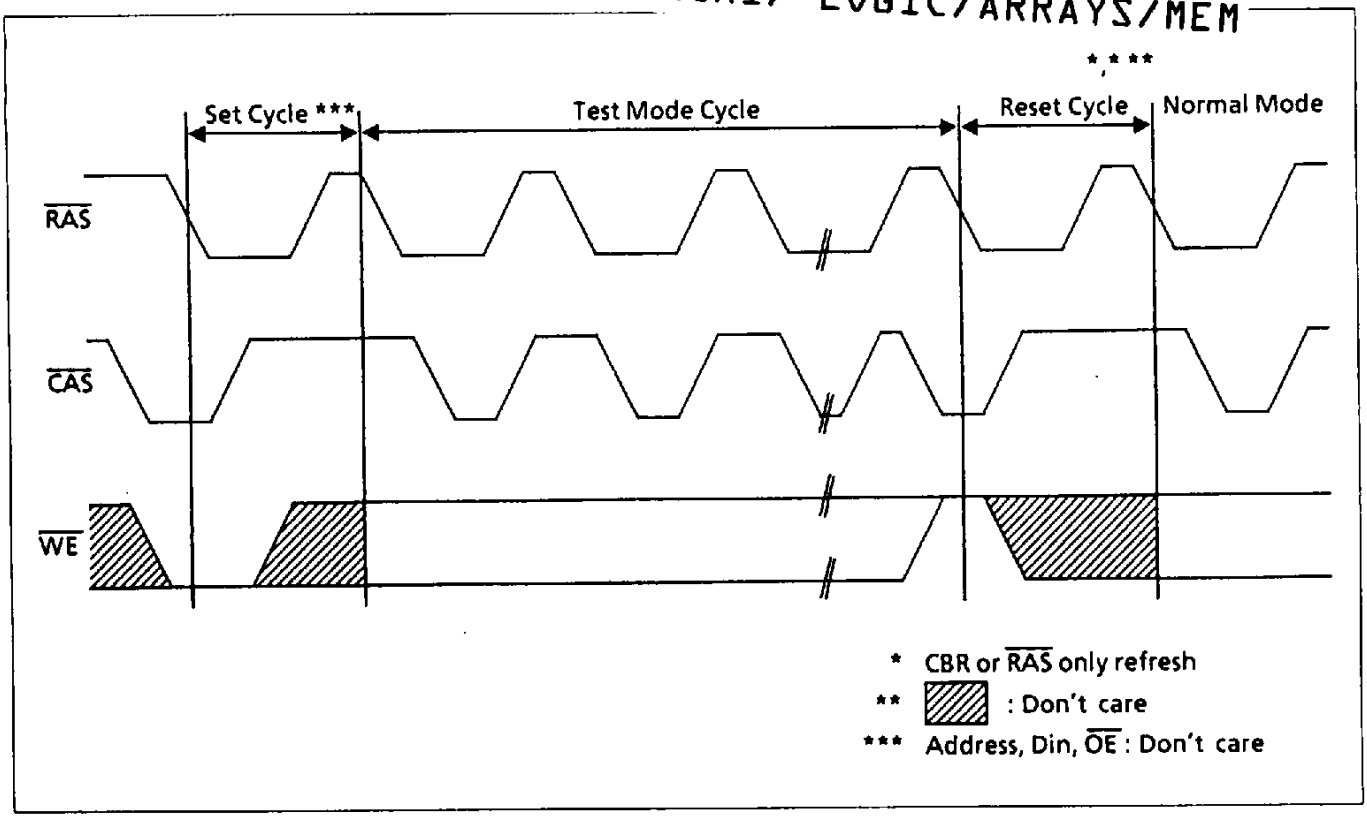
Fast Page Delayed Write Cycle



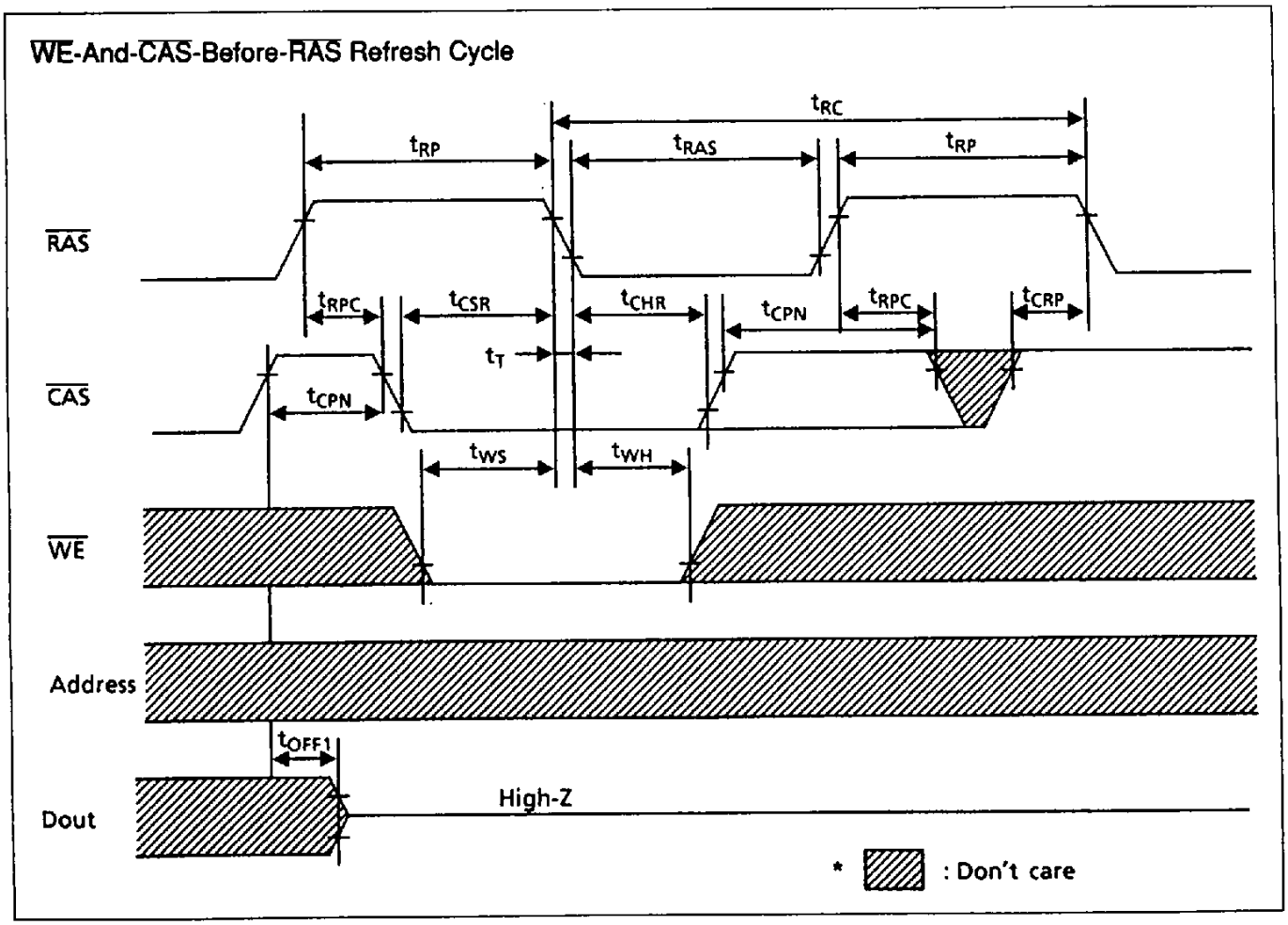
Fast Page Mode Read-Modify-Write Cycle



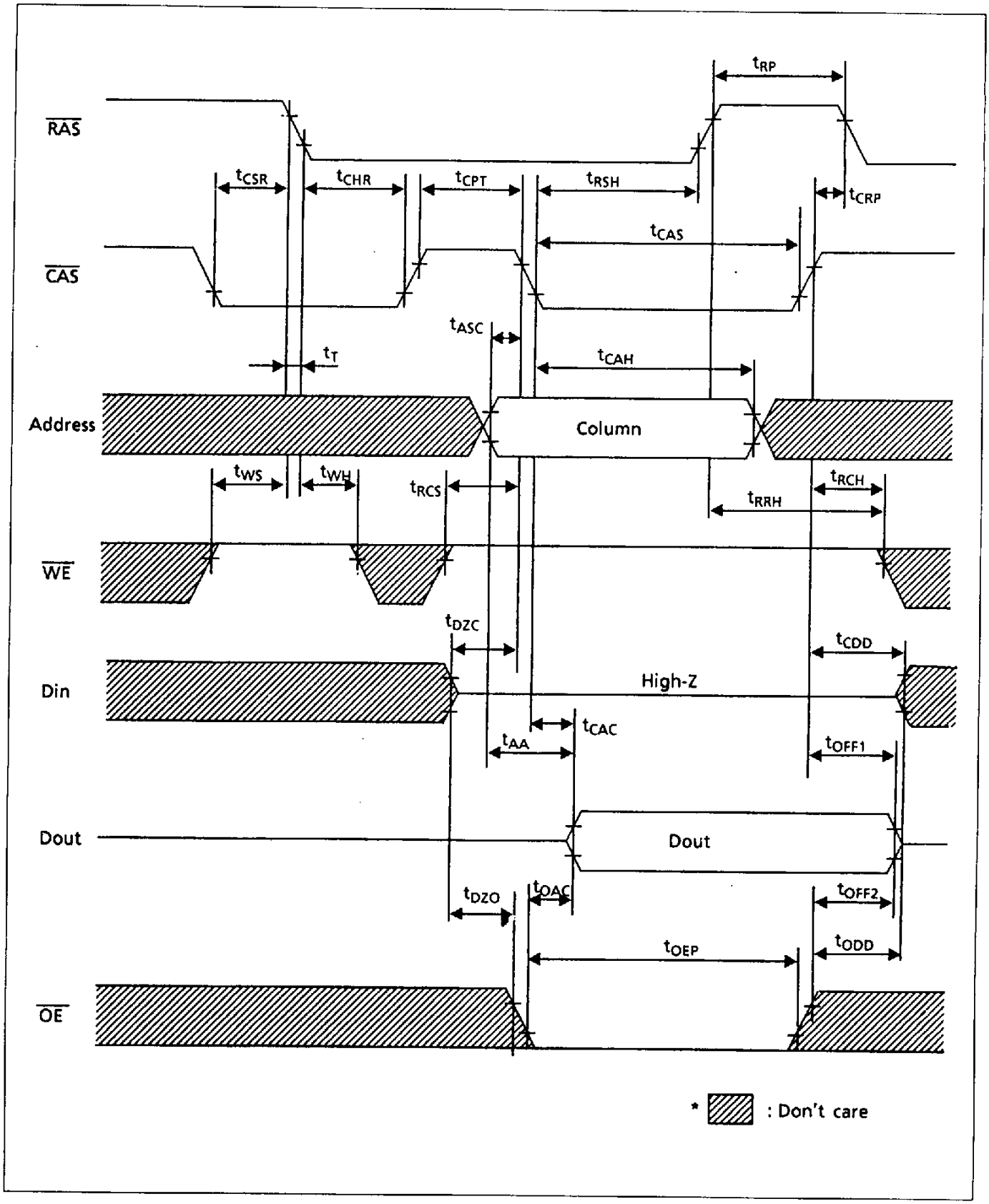
Test Mode Cycle



Test Mode Set Cycle



CAS-Before-RAS Refresh Counter Check Cycle (Read)



$\overline{CAS}$-Before-$\overline{RAS}$ Refresh Counter Check Cycle (Write)